

## PATENT ASSIGNMENT COVER SHEET

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	ERMOU LIU	09/02/2021
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<b>Property Type</b>	<b>Number</b>	
<b>Application Number:</b>	17436921	
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<b>DATE SIGNED:</b>	09/07/2021	
<b>Total Attachments: 2</b>		
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## **ASSIGNMENT**

WHEREAS I/We, **Ermou LIU of 19F-A, B, C, D, E, F, G, H, Shenmao Commercial Center, 59 Xinwen Road, Meiling Community, Lianhua Street, Futian District, Shenzhen, Guangdong 518000, China** (hereinafter collectively referred to as the “**ASSIGNOR or ASSIGNORS**”), have invented certain new and useful improvements in:

### **METHOD FOR DATA EXTRACTION, TERMINAL DEVICE AND COMPUTER-READABLE STORAGE MEDIUM**

(hereinafter referred to as the “**INVENTION**”) which claims priority to **PCT** Application No. **PCT/CN2019/076990**, filed on **March 5, 2019**, for which we are about to file an application for a United States Patent (hereinafter collectively referred to as the “**APPLICATIONS**”);

AND WHEREAS, **SHENZHEN TINYSOFT CO., LTD.**, (hereinafter referred to as “**ASSIGNEE**”), a corporation organized and existing under the laws of the Country of **China**, having a place of business at **19F-A, B, C, D, E, F, G, H, Shenmao Commercial Center, 59 Xinwen Road, Meiling Community, Lianhua Street, Futian District, Shenzhen, Guangdong 518000, China**, is desirous of acquiring an interest in any and all countries, in and to the **INVENTION**, the **APPLICATIONS**, and any and all Patents to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, we, the **ASSIGNORS**, have assigned and transferred, and hereby assign and transfer unto **ASSIGNEE**, the entire right, title and interest in and to the **INVENTION**, the **APPLICATIONS**, and any and all Patents that may be issued therefrom, in any and all countries, including any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to **ASSIGNEE**; and we do hereby agree that we will execute all papers necessary in connection with any and all patent applications when called upon to do so by **ASSIGNEE**, its successors or assigns, and that we will, at the cost and expense of **ASSIGNEE**, fully assist and cooperate in all matters in connection with any and all patent applications and Patents issuing thereon.

The undersigned declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are

punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the APPLICATIONS or any Patents issuing thereon.

Date: 2021.9.2

*Ermou LIU*

INVENTOR NAME: Ermou LIU